

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
MUN GYU KIM	03/12/2018
SEUNG JIN YEO	03/12/2018
DONG GWI CHOI	03/12/2018
KYOUNG TAE KIM	03/12/2018
RECEIVING PARTY DATA	
Name:	DB HITEK CO., LTD.
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Internal Address:	GYEONGGI-DO
City:	BUCHEON-SI
State/Country:	KOREA, REPUBLIC OF
Postal Code:	14519
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	15918919
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SIGNATURE:	/Andrew D. Fortney/
DATE SIGNED:	03/12/2018
Total Attachments: 2	
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Attorney Docket No.: **OPP-GZ-2017-0007-US-00**

ASSIGNMENT

For good and valuable consideration, the receipt of which is hereby acknowledged, I, the undersigned,

Mun Gyu KIM

Seung Jin YEO

Dong Gwi CHOI

Kyoung Tae KIM

who have created a certain invention for which an application for United States Letters Patent was executed by me concurrently herewith and entitled:

HALF-POWER BUFFER AND/OR AMPLIFIER

Do hereby sell, assign and transfer to **DB HiTek Co., Ltd.**, a corporation of **the Republic of Korea** having a place of business at **99, Sudo-ro, Wonmi-gu, Bucheon-si, Gyeonggi-do 14519 Republic of Korea**

its successors, assigns, and legal representatives, the full and exclusive right to said invention and said application and to any and all inventions described in said application for the United States, its territorial possessions and all foreign countries, and the entire right, title and interest in and to any and all Letters Patent which may be granted therefor in the United States, its territorial possessions and all foreign countries; and in and to any and all continuations-in-part, continuations, divisions, substitutes, reissues, extensions thereof, and all other applications for Letters Patent relating thereto which have been or shall be filed in the United States, its territorial possessions and/or any foreign countries, and all rights, together with all priority rights, under any of the international conventions, unions, agreements, acts, and treaties, including all future conventions, unions, agreements, acts, and treaties.

Agree that **DB HiTek Co., Ltd.**, hereinafter referred to as Assignee, may apply for and receive Letters Patent for said invention and said inventions, hereinafter referred to as said invention, in its own name, in the United States, its territorial possessions, and all foreign countries; and that, when requested to carry on in good faith the intent and purpose of this assignment, at the expense of said Assignee, its successors, assigns and legal representatives, the undersigned will execute all continuations-in-part, continuations, divisions, substitutes, reissues, extensions thereof, execute all rightful oaths, assignments, powers of attorney and other papers, testify in any legal or quasi legal proceedings, communicate to said Assignee, its successors, assigns or legal representatives all facts known to the undersigned relating to said invention and the history thereof, and generally do everything possible which said Assignee, its successors, assigns, or legal representatives shall consider desirable for aiding in securing, maintaining and enforcing proper patent protection for said invention and for vesting title to said invention and all applications for patents on said invention in said Assignee, its successors, assigns, or legal representatives, and

Covenant with said Assignee, its successors, assigns, or legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others, by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

IN TESTIMONY WHEREOF I have hereunto set MY signature on the date indicated below.

Full Name of Sole/First Inventor: Mun Gyu KIM	
Inventor's Signature: 	Date: Month/Day/Year 05/12/18

Full Name of Second Inventor, if any: Seung Jin YEO	
Inventor's Signature: 	Date: Month/Day/Year 05/12/18

Attorney Docket No.: OPP-GZ-2017-0007-US--00

Full Name of Third Inventor, if any: Dong Gwi CHOI	
Inventor's Signature: 	Date: Month/Day/Year 03/12/18

Full Name of Fourth Inventor, if any:	
Kyoung Tae KIM	
Inventor's Signature:	Date: Month/Day/Year
	05/12/18

Full Name of Fifth Inventor, if any:	
Inventor's Signature:	Date: Month/Day/Year

Full Name of Sixth Inventor, if any:	
Inventor's Signature:	Date: Month/Day/Year

Full Name of Seventh Inventor, if any.	
Inventor's Signature:	Date: Month/Day/Year

Full Name of Eighth Inventor, if any:	
Inventor's Signature:	Date: Month/Day/Year

Full Name of Ninth Inventor, if any:	
Inventor's Signature:	Date: Month/Day/Year

Customer No. 36872

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